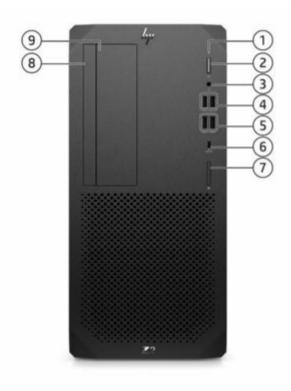
Overview

HP Z2 Tower G5 Workstation

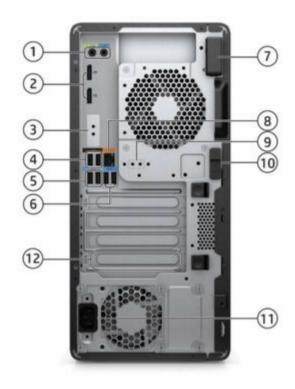


front

- 1. HDD Activity LED
- 2. Power button
- 3. Universal audio jack (with CTIA & OMTP headset support)
- 4. 2 Type-A SuperSpeed USB 5 Gbps signaling rate port (1 charge supports up to 5V/2.1A)
- 5. 2 Type-A SuperSpeed USB 10Gbps signaling rate port

- 6. 1 Type-C[®] SuperSpeed USB 10Gbps signaling rate port (optional, charge supports up to 5V/3A)
- 7. SD card reader 4.0 (optional)
- 8. Slim ODD bay
- 9. External 5.25" bay

Overview



rear

- 1. 1 Audio Line-in / Audio Line-out
- 2. 2 DisplayPortTM 1.4*
- 3. Flex IO modules, choice of:

 VGA, HDMI 2.0b, DisplayPortTM 1.4*, Dual Type-A SuperSpeed USB 5Gbp 5.

 signaling rate port, 2nd 1GbE LAN, Type-C® SuperSpeed USB 10Gbps
 signaling rate port (Alt Mode)

 11.
- 4. 2 High-Speed USB 480Mbps signaling rate port
- 5. 2 Type-A SuperSpeed USB 10Gbps signaling rate port
- 6. 2 Type-A SuperSpeed USB 5Gbps signaling rate port

- 7. WLAN antenna (optional)
- 8. RJ-45
- 9. 2nd serial port (optional)

Hood lock (optional)

- 11. Power connector
- 12. Type-C® ThunderboltTM 3 Dual-port (optional)

Form Factor

Tower

Operating Systems

Preinstalled:

- Windows 10 Pro 64¹
- Windows 10 Pro for Workstations 64¹
- Windows 10 Home 64¹
- Linux®-ready²

Web-supported only:

• Windows 10 Enterprise 641

Supported Version:

 HP tested Windows 10, version 1809 on this platform. For testing information on newer versions of Windows 10, please see:

https://support.hp.com/document/c05195282.

¹ Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or

Overview

separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionalit Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements apply over time for updates. See http://www.windows.com.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the H support website. https://support.hp.com/us-en/document/c05195282

All onboard Display support DP1.4/HBR2 when video output is via Intel Graphics.

²For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_markers In accordance with Microsoft's support policy, HP does not support the Windows® 7 operating system on products configured with Intel® 7th Generation and forward processors.

Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Integrated Graphics	Intel® Turbo Boost Technology³	Featuring Intel® vPro® Technology ⁴	16GB Intel® Optane TM memory ²	TDP (W)
Intel® Core TM i9- 10900K Processor	10	3.7	20	2933	Y	Intel® UHD Graphics 630	5.2	Υ	Υ	125
Intel® Core TM i9- 10900 Processor	10	2.8	20	2933	Υ	Intel® UHD Graphics 630	5.1	Υ	Υ	65
Intel® Core TM i9- 10900F Processor	10	2.8	20	2933	Υ	N/A	5.1	Y	Υ	65
Intel® Core TM i7- 10700K Processor	8	3.8	16	2933	Y	Intel® UHD Graphics 630	5.1	Y	Υ	125
Intel [®] Core TM i7- 10700 processor	8	2.9	16	2933	Y	Intel® UHD Graphics 630	4.8	Y	Υ	65
Intel® Core TM i5- 10600K processor	6	4.1	12	2666	Y	Intel® UHD Graphics 630	4.8	Y	Υ	125
Intel® Core TM i5- 10600 processor	6	3.3	12	2666	Y	Intel® UHD Graphics 630	4.8	Y	Υ	65
Intel® Core TM i5- 10500 processor	6	3.1	12	2666	Y	Intel® UHD Graphics 630	4.5	Y	Υ	65
Intel® Core TM i5- 10400 processor	6	2.9	12	2666	Y	Intel® UHD Graphics 630	4.3	Y	Υ	65
Intel® Core TM i5- 10400F processor6	6	2.9	12	2666	Y	N/A	4.3	Y	Υ	65
Intel® Core TM i3- 10320 processor6	4	3.8	8	2666	Y	Intel® UHD Graphics 630	4.6	Y	Υ	65
Intel® Core TM i3- 10300 processor	4	3.7	8	2666	Y	Intel® UHD Graphics 630	4.4	Y	Υ	65
Intel® Core TM i3- 10100 processor	4	3.60	6	2666	Υ	Intel® UHD Graphics 630	4.3	Υ	Υ	65
Intel® Xeon® W- 1290P processor	10	3.7	20	2933	Υ	Intel® UHD Graphics P630	5.2	Υ	Υ	125
Intel® Xeon® W-1290 processor6	10	3.2	20	2933	Y	Intel® UHD Graphics P63(5 1	Y	Υ	80
Intel® Xeon® W- 1270P processor6	8	3.8	16	2933	Y	Intel® UHD Graphics P630	E 1	Υ	Υ	125
Intel® Xeon® W-1270 processor	8	3.4	16	2933	Υ	Intel® UHD Graphics P63(5.0	Υ	Υ	80
Intel® Xeon® W- 1250P processor	6	4.1	12	2666	Y	Intel® UHD Graphics P63(4.8	Y	Υ	125

Overview

Intel® Xeon® W-1250 processor	6	3.3	12	2666	Υ	Intel® UHD Graphics P630	4.7	Y	Υ	80

- 1. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessaril benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware as software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
- 2. Intel® OptaneTM memory system acceleration does not replace or increase the DRAM in your system.
- 3. The specifications shown in the Intel® Turbo Boost Technology column represent the maximum turbo frequency with one core active. boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turbobo for more information
- 4. For full Intel® vProTM functionality, Windows 10 Pro 64 bit, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or WLAN card and TPM 2.0 are required. Some functionality requires additional 3rd party software in order to run. See http://intel.com/vpro

6. Available in Q4, 2020

ColorBlackConvertibilityNoExpansion Slots (seeSlot 1:

system board section for PCle Gen3 x16

more details)

Slot 2:

PCle Gen3 x1 - with x4 Connector

Slot 3:

PCIe Gen3 x1 - with x4 Connector

Slot 4:

PCIe Gen3 x4 - with x16 Connector

Expansion Bays (see 2 internal 3.5" bays storage section for more 1 external 5.25" bay

details) 1 internal 2.5" bay (for SSD only)

1 dedicated 9.5mm slim optical disk drive bay

Front I/O 2 Type-A SuperSpeed USB 5Gbps signaling rate port, 2 Type-A SuperSpeed USB 10Gbps signaling rate port, 1

Type-C® SuperSpeed USB 10Gbps signaling rate port (optional), 1 SD card reader 4.0 (optional), 1 universal aud

jack

Internal I/O 1 Hi-Speed USB 480Mbps signaling rate port

Rear I/O 2 DisplayPortTM 1.4, 1 Audio Line in/out, 1 RJ-45, 2 Hi-Speed USB 480Mbps signaling rate port, 2 Type-A

SuperSpeed USB 10Gbps signaling rate port, 2 Type-A SuperSpeed USB 5Gbps signaling rate port, 1 serial port (optional), 1 serial and PS/2 combo (optional), 1 Flex I/O port (choice of VGA, HDMI 2.0b, DisplayPortTM 1.4, Type C® SuperSpeed USB 10Gbps signaling rate port (Alt mode), Dual Type-A SuperSpeed USB 5Gbps signaling rate

port, 2nd 1GbE LAN), ThunderboltTM 3 (40Gbs signaling rate port, optional, cabled to PCIe AIC)

NOTE: All DisplayPortTM support DP1.4/HBR2 when video output is via Intel Graphics.

Interfaces Supported SD Media Card Reader (optional)

On-board RAID Support RAID 0

RAID 1

Chassis Dimensions (H x WH: 14" [356mm] **x D)** W: 6.7" [169mm]

D: 15.2" [385mm]

Overview

Packaged Dimensions H: 20.39" (518mm)

W: 11.61" (295mm) D: 19.29" (490mm)

Rack Dimensions 5U

Weight Exact weights depend upon configuration (System weight only).

Starting at 7kg (15.43lbs.)

Temperature Operating: 5° to 35° C (40° to 95° F)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every

305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

Humidity Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude (non-

pressurized)⁶

Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)
Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Temperature for details.

Power Supply 700W wide-ranging, active Power Factor Correction, 92% Efficiency. 500W wide-ranging, active Power Factor

Correction, 90% Efficiency. 350W wide-ranging, active Power Factor Correction, 92% Efficiency.

NOTE: The Power Supply Efficiency Report for the 700W 92% Efficiency, 500W 90% Efficiency and 350W 92%

Efficiency Power Supply may be found at the following links:

700W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

500W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

350W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

Backup Devices For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup System

offerings, please visit http://www.hp.com/go/connect

Chipset Intel® W480 chipset



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	10th Generation Intel Core Processors ¹				
	Intel Core i9-10900K processor	Υ	N		
	Intel Core i9-10900 processor	Υ	N		
	Intel Core i9-10900F processor	Υ	N		1
	Intel Core i7-10700K processor	Υ	N		
	Intel Core i7-10700 processor	Υ	N		
	Intel Core i5-10600K processor	Υ	N		
	Intel Core i5-10600 processor	Υ	N		
	Intel Core i5-10500 processor	Υ	N		
	Intel Core i5-10400 processor	Υ	N		
	Intel Core i5-10400F processor	Υ	N		1
	Intel Core i3-10320 processor	Υ	N		2
	Intel Core i3-10300 processor	Υ	N		2
	Intel Core i3-10100 processor	Υ	N		
	Intel Xeon W Processors				
	Intel Xeon W-1290P processor	Υ	N		
	Intel Xeon W-1290 processor	Υ	N		2
	Intel Xeon W-1270P processor	Υ	N		2
	Intel Xeon W-1270 processor	Υ	N		
	Intel Xeon W-1250P processor	Υ	N		
	Intel Xeon W-1250 processor	Υ	N		
	¹ These processors support only non-ECC memory				

¹These processors support only non-ECC memory

NOTE 1: No iGfx. A discrete graphics card must be purchased at the same time. Avaiable in Q4, 2020

NOTE 2: Available in Q4, 2020

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA
	2TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ		
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Υ	Υ	WOR10AA
	2TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Υ	Υ	2Z274AA
	4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Υ	Υ	K4T76AA
	8TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Υ	Υ	2Z273AA
	500GB SATA 7.2K SED SFF HDD	Υ	Υ	D8N29AA

Supported Componen	ts			
SATA Solid State Drives	HP 256GB SATA 6Gb/s SSD	Υ		A3D26AA
	HP 512GB SATA 6Gb/s SSD	Υ		D8F30AA
	HP 1TB SATA 6Gb/s SSD	Υ		F3C96AA
	HP 2TB SATA 6Gb/s SSD	Υ		Y6P08AA/AT
	HP 256GB SATA 6Gb/s SED Opal 2 SSD	Υ		G7U67AA
	HP 512GB SATA 6Gb/s SED Opal 2 SSD	Υ		N8T26AA
PCIe Solid State Drives	PCIe SSDs for HP Workstations			
	HP ZTurbo 1TB TLC Z2 G5 TWR/SFF SSDKit	Υ	Υ	141L5AA/AT
	HP ZTurbo 256GB SED Z2 G5 TWR/SFF SSDKit	Υ	Υ	141L8AA/AT
	HP ZTurbo 256GB TLC Z2 G5 TWR/SFF SSDKit	Υ	Υ	141L7AA/AT
	HP ZTurbo 2TB TLC Z2 G5 TWR/SFF SSDKit	Υ	Υ	141M1AA/AT
	HP ZTurbo 512GB SED Z2 G5 TWR/SFF SSDKit	Υ	Υ	141M3AA/AT
	HP ZTurbo 512GB TLC Z2 G5 TWR/SFF SSDKit	Υ	Υ	141M5AA/AT

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 3 reserved for system recovery software.

Hard Drive Controllers		Factory Configured	Option Kit
	Integrated SATA Controller (Z2 G5)		
	Integrated SATA Controller, RAID 0,1 supported: 4x 6 Gb/s ports	Υ	
	Factory integrated RAID on motherboard for SATA drives		
	RAID 0 Data Configuration	Υ	
	RAID 1 Data Configuration	Υ	
	Factory integrated RAID on motherboard for Z Turbo Drive		
	RAID 0 Boot or Data Configuration	Υ	
	RAID 1 Boot or Data Configuration	Υ	
	NOTE: CATA handware DAID is not supported on Linux® systems. The	المستوا المستوا	in health in and second

NOTE: SATA hardware RAID is not supported on Linux® systems. The Linux® kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. All drives must be identical in type and capacity. Boot volume/RAID array must be less than 2 TB

NOTE: Requires identical drives (speeds, capacity, and interface).

NOTE: The HP Z2 Tower G5 Workstation is capable of configuring up to 2 Z Turbo Drives. By default, the Z Turbo Drive configured will be installed in the M.2 storage slot on the system's motherboard. **NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for system recovery software.

NOTE: The HP Z2 Tower G5 Workstation is capable of configuring up to 2 Z Turbo Drives. By

Supported Components

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Supported # of cards
	Graphics Cable Adapters				
	HP USB-C to DisplayPort Adapter	Υ	Υ	4SH08AA	
	HP USB-C to HDMI Adapter	Υ	У	4SH07AA	
	HP USB-C to VGA Adapter	Υ	у	4SH06AA	
	HP DisplayPort To DVI-D Adapter	Υ	Υ	FH973AA	
	HP DisplayPort To VGA Adapter	Υ	Υ	AS615AA	
	HP DisplayPort To HDMI True 4k Adapter	Υ	у	2JA63AA	
	HP Single miniDP-to-DP Adapter Cable	Υ	Υ	2MY05AA	
	Entry 3D				
	NVIDIA® Quadro® P400 2GB Graphics	Υ	Υ	1ME43AA/AT ¹	2
	NVIDIA® Quadro® P620 2GB Graphics	Υ	Υ	3ME25AA/AT ¹	2
	Mid-range 3D				
	AMD Radeon [™] Pro WX 3200 4GB Graphics	Υ	Υ	6YT68AA/AT ¹	2
	NVIDIA® Quadro® P1000 4GB Graphics	Υ	Υ	1ME01AA/AT ¹	2
	NVIDIA® Quadro® P2200 5GB Graphics	Υ	Υ	6YT67AA/AT	1
	High End 3D				
	NVIDIA® Quadro® RTX 4000 8GB Graphics	Υ	Υ	5JV89AA/AT	1
	AMD Radeon TM Pro W5500 8GB Graphics ²	Υ	Υ	9GC16AA/AT	1
	AMD Radeon™ Pro W5700 8GB Graphics²	Υ	Υ	9GC15AA/AT	1
	Ultra High-End 3D				
	NVIDIA® Quadro® RTX 5000 16GB Graphics	Υ	Υ	5JH81AA/AT	1
	NVIDIA® Quadro® RTX 6000 24GB Graphics	Υ	Υ	5JH80AA/AT	1
	¹ Option kits include 2x miniDP-to-DP adapter ² Available in Q4, 2020	S			

Memory		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 4GB (1x4GB) DDR4-3200 nECC UDIMM	Υ			2, 3
	HP 8GB (2x4GB) DDR4-3200 nECC UDIMM	Υ			3
	HP 8GB (1x8GB) DDR4-3200 nECC UDIMM	Υ			2, 3
	LID OCD (1, OCD) DDD4 3300 ECC LIDIMM	v			1 2 2 4

HP 8GB (2x4GB) DDR4-3200 nECC UDIMM	Υ	3
HP 8GB (1x8GB) DDR4-3200 nECC UDIMM	Υ	2,3
HP 8GB (1x8GB) DDR4-3200 ECC UDIMM	Υ	1, 2, 3, 4
HP 16GB (2x8GB) DDR4-3200 nECC UDIMM	Υ	3
HP 16GB (2x8GB) DDR4-3200 ECC UDIMM	Υ	1, 3, 4
HP 16GB (1x16GB) DDR4-3200 nECC UDIMM	Υ	2,3
HP 16GB (1x16GB) DDR4-3200 ECC UDIMM	Υ	1, 2, 3, 4
HP 24GB (3x8GB) DDR4-3200 nECC UDIMM	Υ	3
HP 24GB (3x8GB) DDR4-3200 ECC UDIMM	Υ	1, 3, 4
HP 32GB (4x8GB) DDR4-3200 nECC UDIMM	Υ	3
HP 32GB (4x8GB) DDR4-3200 ECC UDIMM	Υ	1, 3, 4
HP 32GB (2x16GB) DDR4-3200 nECC UDIMM	Υ	3
HP 32GB (2x16GB) DDR4-3200 ECC UDIMM	Υ	1, 3, 4



Supported Components

HP 32GB (1x32GB) DDR4-3200 nECC UDIMM	Υ	2, 3
HP 32GB (1x32GB) DDR4-3200 ECC UDIMM	Υ	1, 2, 3, 4
HP 64GB (4x16GB) DDR4-3200 nECC UDIMM	Υ	3
HP 64GB (4x16GB) DDR4-3200 ECC UDIMM	Υ	1, 3, 4
HP 64GB (2x32GB) DDR4-3200 nECC UDIMM	Υ	3
HP 64GB (2x32GB) DDR4-3200 ECC UDIMM	Υ	1, 3, 4
HP 128GB (4x32GB) DDR4-3200 nECC UDIMM	Υ	3
HP 128GB (4x32GB) DDR4-3200 ECC UDIMM	Υ	1, 3, 4

NOTES:

- 1 Intel® Xeon processors can support either ECC or non-ECC memory; Intel® CoreTM> only support non-ECC memory.
- 2 Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be insert into each channel.
- 3 Max transfer rates up to 2933 MT/s

AMO

HP 4GB (1x4GB) DDR4-3200 nECC UDIMM	Υ	Υ	141J1AA/AT	
HP 8GB (1x8GB) DDR4-3200 nECC UDIMM	Υ	Υ	141J4AA/AT	
HP 8GB (1x8GB) DDR4-3200 ECC UDIMM	Υ	Υ	141J3AA/AT	1, 4
HP 16GB (1x16GB) DDR4-3200 nECC UDIMM	Υ	Υ	141H3AA/AT	
HP 16GB (1x16GB) DDR4-3200 ECC UDIMM	Υ	Υ	141H2AA/AT	1, 4
HP 32GB (1x32GB) DDR4-3200 nECC UDIMM	Υ	Υ	141H9AA/AT	
HP 32GB (1x32GB) DDR4-3200 ECC UDIMM	Υ	Υ	141H7AA/AT	1, 4

¹ Intel® Xeon® processors can support either ECC or non-

ECC memory; Intel® CoreTM> processors only support non-ECC memory.

² Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be insert into each channel.

³ The CPUs determine the speed at which the memory is clocked. If a 2666 MT/s capable CPU is used in the sy the maximum speed the memory will run at is 2666 MT/s regardless of the specified speed of the memory. 4 ECC or nECC memory availability depends on processor configuration.

Supported Components

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number
	HP 9.5mm Slim DVD Writer	Υ	Υ	2ZK26AA
	HP DX175 Removable HDD Frame/Carrier	Υ	Υ	1ZX71AA
	HP DX175 Removable HDD Spare Carrier	Υ	Υ	1ZX72AA
	HP SD card reader Z2 TWR	Υ	Υ	141K3AA/AT
	HP 9.5mm Slim BDXL Blu-Ray Writer	Υ	Υ	K3R65AA
	HP 9.5mm Slim DVD-ROM Drive	Υ	Υ	K3R63AA

NOTE: With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do no constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray tit to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE: HD-DVD disks cannot be played on the DVD-ROM Drive. No support for DVD RAM.

Input Devices		Factory Configured	Option Kit	Option Kit Part Number
	HP Premium Wireless Keyboard	Υ	Υ	Z9N41AA/AT
	HP USB 320K Keyboard	Υ	Υ	9SR37AA
	HP USB Business Slim Wired SmartCard CCID Keyboard	Υ	N	
	HP USB Premium Wired Keyboard PROMO	Υ	Υ	Z9N40AT
	HP 320M Wired Mouse	Υ	Υ	9VA80AA
	HP USB Premium Mouse	Υ	Υ	1JR32AA
	HP Wireless Premium Mouse	Υ	Υ	1JR31AA
	3Dconnexion CADMouse	N	Υ	M5C35AA
	HP Promo PS/2 Mouse	N	Υ	QY775AT
	HP Wired Desktop 320MK Mouse and Keyboard	N	Υ	9SR36AA

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number
	HP Thunderbolt 3 PCIe Card Z2 Tower	Υ	Υ	141M7AA
	HP Z2 Internal Serial Port and PS/2 Port	Υ	Υ	141K9AA/AT
	HP Z2 Power Cord Kit	Υ	Υ	1N1D5AA
	HP Z2 2nd serial port adapter	Υ	Υ	141K8AA/AT
	HP Z2 Tower Dust Filter	Υ	Υ	141L2AA/AT
	HP Z2 Tower Dust Filter and bezel	Υ	Υ	141L3AA/AT
	HP 800/600/400 G3 Serial/ PS/2 Adapter	Υ	Υ	1VD82AA
	HP PCIe x1 Parallel Port Card	Υ	Υ	N1M40AA
	HP DP Flex Port 2020	Υ	Υ	141J7AA/AT
	HP 1GbE LAN Flex Port 2020	Υ	Υ	141J6AA/AT
	HP Dual USB-A 3.2 Gen1 Flex 2020	Υ	Υ	141J8AA/AT
	HP Front USB-C 3.2 Gen2 2020 TWR	Υ	Υ	141K0AA
	HP HDMI Flex Port 2020	Υ	Υ	141K1AA/AT
	HP USB-C 3.2 Gen2 Alt Flex Port 2020	Υ	Υ	141K6AA/AT

Supported Components

HP VGA Flex Port 2020 Y Y 141K7AA/AT

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number
	Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro® with Inte AMT 12.0)	l® A	N	
	Aquantia AQN-108 1-Port 5GbE NIC	Υ	Υ	1PM63AA
	HP 10GbE SFP+ SR Tranceiver	Υ	Υ	C3N53AA
	Intel Ethernet I350-T4 4-Port 1Gb NIC	Υ	Υ	W8X25AA
	Intel X550 10GBASE-T Dual Port NIC	Υ	Υ	1QL46AA
	Intel X710-DA2 10GbE SFP+ DP NIC	Υ	Υ	1QL47AA
	Intel Ethernet I350-T2 2-Port 1Gb NIC	Υ	Υ	V4A91AA
	Intel® AX201 802.11 a/b/g/n/ac/ax WLAN + Bluetooth 5.0 M.2 NIC	Υ	N	

NOTE 1: The integrated network connection is required to support Intel® vProTM Technology.

NOTE 2: If AMT is provisioned, then network teaming with the integrated LAN port is not possible.

NOTE 3: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	HP Z2 Mini and Z2/Z4/Z6 TWR Depth Adjustable Fixed Rail Rack Kit	Y	Υ	2A8Y5AA

Software		Factory Configured	Option Kit	Support Notes
	HP Performance Advisor	Υ	N	1
	HP PC Hardware Diagnostics UEFI (Windows OS only)	Υ	N	2
	HP PC Hardware Diagnostics Windows	Υ	N	
	ZCentral Remote Boost	Υ	N	
	HP Sure Sense	Υ	N	
	HP Notifications	Υ	N	
	HP Desktop Support Utility	Υ	N	
	HP Documentation	Υ	N	
	HP Image Assistant	N	N	
	HP Support Assistant	N	N	
	A Construction of a state of the following and a sign of the following			

^{1.} Supports, and preinstalled with Windows 10 only. Also available as a free download from http://www.hp.com/go/performanceadvisor

^{2.} Windows OS only

Supported Components

Operating Systems

Windows 10 Pro 64

Windows 10 Pro 64 Workstation

Windows 10 Home 64

Linux Ready

1. For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Z2 G5 Workstation into the enterprise, such as PXE, remote recovery, remote configuration, remote control, and BIOS (F10) Setup support for 14 languages.
- Network firmware updates Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification version 2.6
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Workstation computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP
 Workstation computers, including BIOS updates from within Windows (HP
 Firmware Update and Recovery), HP Client Manager, and fail-safe recovery.
 In addition, the HP BIOS Configuration Utility enables replication of BIOS
 settings within Windows while the Replicated Setup feature provides the same
 capability within BIOS (F10) Setup. The BIOS Configuration Utility is available
 from the HP support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S4/S5 Maximum Power Savings setting supports EU Lot6 requirement and

Supported Components

allows the computer to power down below 0.5W in S4/S5 (when turned off). When S4/S5 Maximum Power Savings feature is enabled below features are turned off:

- -Power to expansion connectors / slots
- -Wake events other than power buttons (such as wake on LAN)
- -USB charging ports

HP Sure Start Gen6

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.
- Audit enabled System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating

HP Sure Start Gen6 is available on select HP PCs and requires Windows 10.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

BIOS

HP BIOSphere Gen6³⁹
BIOS Update via Network
HP Secure Erase⁴⁰
Absolute Persistence Module⁴¹
Pre-boot Authentication
HP Wake on WLAN
HP DriveLock & Automatic DriveLock

Software

HP Support Assistant

HP Image Assistant

HP Desktop Support Utility

HP Documentation

HP Notifications

HP PC Hardware Diagnostics UEFI

HP PC Hardware Diagnostics Windows

HP Performance Advisor²⁴

ZCentral Remote Boost²⁸

Manageability Features

HP Driver Packs²²

HP System Software Manager (SSM)

HP BIOS Config Utility (BCU)

HP Manageability Integration Kit Gen4²³

Supported Components

Client Security Software

HP Client Security Manager Gen6 ²⁵ including: (including Credential Manager, HP Password Manager²⁶, HP Spare Key) HP Sure Run Gen3³⁵ HP Power On Authentication Microsoft Defender²⁷

Security Management

HP Sure Click³⁸
HP Sure Start Gen6
HP Sure Sense²⁹
HP Sure Recover Gen3³⁶

[22] HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

[23] HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html

[24] HP Performance Advisor Software - HP Performance Advisor is ready and waiting to help you get the most out of your HP Works from day one—and every day after. Learn more or download at: https://www8.hp.com/us/en/workstations/performance-advisor.ht [25] HP Client Security Manager Gen6 requires Windows and is available on the select HP Elite and Pro PCs.

[26] HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. may need to enable or allow the add-on / extension in the internet browser.

[27] Microsoft Defender Opt in and internet connection required for updates.

[28] HP Z Central Remote Boost Software does not come preinstalled on Z Workstations but can be downloaded and run on all Z desk laptops without license purchase. With non-Z sender devices, purchase of perpetual individual license or perpetual floating license pe simultaneously executing versions and purchase of ZCentral Remote Boost Software Support is required. Zcentral Remote Boost required Windows, RHEL (7 or 8), UBUNTU 18.04 LTS, or HP ThinPro 7 operating systems. MacOS (10.13 or newer) operating system is only su on the receiver side. Requires network access. The software is available for download at hp.com/ZCentralRemoteBoost.

[29] HP Sure Sense requires Windows 10 Pro or Enterprise. See product specifications for availability.

[35] HP Sure Run is available on HP Workstation products equipped with 8th generation Intel® or AMD® processors.

[36] HP Sure Recover Gen3 is available on select HP PCs and requires an open network connection. You must back up important files, of photos, videos, etc. before using HP Sure Recover to avoid loss of data.

[38] HP Sure Click requires Windows 10 Pro or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

[39] HP BIOSphere Gen6 Features may vary depending on the platform and configurations.

[40] HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clea sanitation method. HP Secure Erase does not support platforms with Intel® OptaneTM.

[41] Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions car purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Reco Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

System Technical Specifications

System Board

System Board Form Factor Customized PCB
Processor Socket Single LGA-1200

CPU Bus Speed DMI

Chipset Intel® PCH W480
Super I/O Controller Nuvoton SIO18

Memory Expansion Slots 4 DDR4 memory slots

Memory Type Supported DDR4, UDIMM (Unbuffered), ECC& non-ECC

Memory Modes Non-Interleaved for single channel. Interleaved when both channels are populated.

Memory Speed Supported 2933MT/s DDR4

Memory Protection ECC available on data

Maximum Memory 128GB

Memory Configuration

(Supported)

4GB, 8GB 16GB and 32GB non-ECC/8GB, 16GB and 32GB ECC unbuffered DIMMs are supported. ECC and non-Ememory DIMMs cannot be mixed in the same system

PCI Express Connectors

- 1 PCI Express Gen3 slot x16 mechanical/ x16 electrical (full height, full length)
- 1 PCI Express Gen3 slot x4 mechanical/ x1 electrical (full height, full length, open-ended)
- 1 PCI Express Gen3 slot x4 mechanical/ x1 electrical (full height, full length, open-ended)
- 1 PCI Express Gen3 slot x16 mechanical/ x4 electrical (full height, full length)
- 2 M.2 2280 Storage (PCle Gen3 x4)
- 1 M.2 2230 WLAN (PCIe Gen3 x1+ Intel CNVi)

In the PCIe Gen3 (x16 electrical/x16 mechanical) slot, it intent to supported HP certified added in card.

Supported Drive Interfaces SATA

Integrated (4) Serial ATA interfaces (6Gb/s SATA).
RAID 0 and 1 supported. Factory integrated RAID for

Microsoft Windows only.

Serial Attached SCSI None

Integrated Graphics Intel® UHD Graphics 630 (on Core i3/i5/i7/i9-10xxx processors);

Intel® Integrated Graphics P630 for Xeon processors

Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics display.

Support for Microsoft DirectX 12, OpenGL 4.5 and OpenCL 2.1 on Intel® UHD Graphics P630;

Based on Unified Memory Architecture (UMA) - a region of system

memory is reserved and dedicated to the graphics display.

Support for Microsoft DirectX 12, OpenGL 4.5 and OpenCL 2.1 on Intel® UHD Graphics P630;

3 DP 1.4 graphics ports integrated in motherboard; Supports up t three simultaneous displays across DisplayPortTM/HDMI*/DVI outputs.

Max. resolution supported on DP 1.4 ports: 4096x2304 @ 60Hz,

24bpp

System Technical Specifications

Network Controller Integrated Ethernet PHY Connection I219LM. Management

capabilities: WOL, PXE 2.1 and AMT 12

Serial Yes- requires optional Serial Port Adapter Kit **2nd Serial** Yes- requires optional Serial Port Adapter Kit

HD Integrated Audio

USB Connector(s) Front 2 Type-A SuperSpeed USB 5Gbps signaling rate port (1 charge

supports up to 5V/2.1A); 2 Type-A SuperSpeed USB 10Gbps signaling rate port; 1 Type-C® SuperSpeed USB 10Gbps signaling

rate port (optional, charge supports up to 5V/3A)

Rear 2 High-speed USB 480Mbps signaling rate port; 2 Type-A

> SuperSpeed USB 5Gbps signaling rate port; 2 Type-A SuperSpeed USB 10Gbps signaling rate port; 1 Type-C® SuperSpeed USB 10Gbp

signaling rate Alt mode port (optional via Flex)

1 High-Speed USB 480Mbps signaling rate port

HD Integrated Audio Yes

Internal

None

Yes

Flash ROM Yes **CPU Fan Header** Yes

Chassis Fan Header 1 Rear System Chassis Fan Header, 1 Graphic chassis Fan Header.

Front PCI Fan Header None **Front Control** Yes

Panel/Speaker Header

CMOS Battery Holder -

Lithium

Memory Fan Header

Integrated Trusted

Integrated TPM 2.0

Platform Module Convertible to FIPS 140-2 Certified mode through firmware v7.85

The TPM module disabled where restricted by law, i.e. Russia.

Power Supply Headers Yes Power Switch, Power LED & Yes

Hard Drive LED Header

Clear Password Jumper None

Keyboard/Mouse USB or PS/2 (option)

Power Supply 700W EPA92, 500W EPA90 and 350W EPA92

[1]Maximum memory capacities assume 64-bit operating systems, such as Genuine Windows® 10 Professional 64 bit, Red Hat Linux 64-b bit Windows Operating Systems support up to 4 GB.

[2]M.2 storage supports compatible devices up to 80mm

PCIe Hold-down / Blower Kit Specification

Please refer to section Supported Components - Graphics for supported cards list.

System Technical Specifications

Performance Class	Product Name	Slots space Required	Max Card Count	Number of Cards Require PCIe Hold-down / Blower Kit
High	NVIDIA® Quadro® RTX TM 6000	2	1	1
	NVIDIA® Quadro® RTX TM 5000	2	1	1
	NVIDIA® Quadro® RTX TM 4000	2	1	1
	AMD Radeon TM Pro W5700	2	1	1
Mid-Range	AMD Radeon TM Pro W5500	1	1	1
	NVIDIA® Quadro® P2200	1	2	1
	NVIDIA® Quadro® P1000	1	2	2
	AMD Radeon TM Pro WX 3200	1	2	2
Entry	NVIDIA® Quadro® P620	1	2	2
	NVIDIA® Quadro® P400	1	2	3

NOTE: The PCIe Hold-down / Blower Kit is required for 700W chassis.

System Configurations						
Example Configuration #1	Processor Info	CPU I Core i5-10400 2.9GHz 6C65W				
	Memory Info	8GB (1x 8GB) 2666 MHz DDR4 non-ECC				
	Graphics Info	Intel® UHD Integrated Graphics 630				
	Disks/Optical/Floppy	1x SATA 1TB 7.2k rpm / 1x 9.5mm Slim ODD				
	PSU	350W				
	Other					

Energy Consumption		115 VAC 230 VAC		100	VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)		2.3	10.	872	11.564	
	Windows short Idle (S0)	13.	599	12.504		13.	423
	Windows Busy Typ (S0)	94.	399	92.031		96.542	
	Windows Busy Max (S0)	112.35 109.536		109.536		.513	
	Sleep (S3)	0.774	0.805	0.766	0.803	0.759	0.808
	Off (S5)	0.505	0.504	0.51	0.51	0.512	0.508
	Zero Power Mode (EuP)	0.	0.21 0.221		0.276		

Heat Dissipation		115 VAC		230	VAC	100	VAC
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	41.967		41.967 37.095		39.	456
	Windows short Idle (S0)	46.	399	9 42.663		45.799	
	Windows Busy Typ (S0)	322	.089	314.009		329.401	
	Windows Busy Max (S0)	Busy Max (S0) 383.338 373.736		.736	390	.718	
	Sleep (S3)	2.64	2.746	2.613	2.739	2.589	2.756
	Off (S5)	1.723	1.719	1.74	1.74	1.746	1.733
	Zero Power Mode (EuP) 0.716 0.754		754	0.941			

System Technical Specifications

Example Configuration #2	Processor Info	CPU I Core i7-10700 2.9GHz 8C65W			
	Memory Info	16GB (2x 8GB) 2666 MHz DDR4 non-ECC			
	Graphics Info	P2200 Graphics			
	Disks/Optical/Floppy	1x SATA 256GB SSD / 1x 9.5mm Slim ODD			
	PSU	500W			
	Other				

Energy Consumption		115 VAC 230 VAC		100 VAC					
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows long Idle (S0)	13.976		13.668		13.856			
	Windows short Idle (S0)	15.	331	15.	15.818		15.818 15.322		322
	Windows Busy Typ (S0)	165	5.25	147.41		167.52			
	Windows Busy Max (S0)	197	197.41 183.52		190.23				
	Sleep (S3)	0.843	0.843 0.883 0.839 0.871		0.851	0.865			
	Off (S5)	0.509	0.506	0.511	0.509	0.512	0.508		
	Zero Power Mode (EuP)	0.	0.21 0.222		0.224				

Heat Dissipation		115 VAC		230 VAC		100 VAC			
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	47.	.686	46.635		47.276			
	Windows short Idle (S0)	52.	.309	53.	53.971		.971 52.278		278
	Windows Busy Typ (S0)	563	3.883	502.912		571.578			
	Windows Busy Max (S0)	673	673.562 626.171		626.171		.065		
	Sleep (S3)	2.876	76 3.012 2.862 2.917		2.903	2.951			
	Off (S5)	1.73	1.726	1.743	1.736	1.746	1.733		
	Zero Power Mode (EuP)	de (EuP) 0.716 0.757		0.764					

Example Configuration #3	Processor Info	CPU I Core	i9-10900K 3	7GHz 10C12	25W			
	Memory Info	64GB (2x 32GB) 2666 MHz DDR4 ECC						
	Graphics Info	RTX2080Ti	Graphics					
	Disks/Optical/Floppy	1x SATA 51	2GB SSD					
	PSU	700W						
	Other							
Energy Consumption		115 VAC 230 VAC 100		VAC				
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows long Idle (S0)	21.	055	20.	603	20.	20.826	
	Windows short Idle (S0)	23.	714	23.	033	23.	492	
	Windows Busy Typ (S0)	297	2.77	284	1.54	295	5.32	
	Windows Busy Max (S0)) 323.41 310.239		312	.456			
	Sleep (S3)	1.36	1.391	1.344	1.371	1.39	1.385	
	Off (S5)	0.52 0.511 0.517 0.513		0.513	0.519	0.512		
	Zero Power Mode (EuP)	0.2	212	0.2	223	0.2	226	

System Technical Specifications

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	71.839		70.297		71.058	
	Windows short Idle (S0)	80.	912	78.588 970.85		80.154	
	Windows Busy Typ (S0)	998	.931			1007.631	
	Windows Busy Max (S0)	110	3.474	1058.535		106	6.099
	Sleep (S3)	4.64	4.746	4.585	4.677	4.742	4.725
	Off (S5)	1.774	1.743	1.764	1.75	1.77	1.746
Zero Power Mode (EuP)		0.716		0.76		0.771	

Example Configuration #4	Processor Info	CPU Xeon W-1270P 3.8GHz 8C125W
	Memory Info	128GB (4x 32GB) 2666 MHz DDR4 ECC
	Graphics Info	RTX6000 Graphics
	Disks/Optical/Floppy	1x SATA 1TB SSD Z Turbo
	PSU	700W
	Other	

Energy Consumption		115 VAC		230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	17.	623	17.	17.283		552
	Windows short Idle (S0)	19.	313	18.848		18.846	
	Windows Busy Typ (S0)	24!	5.58	238.68		248.88	
	Windows Busy Max (S0)	27	5.45	260	5.79	272.89	
	Sleep (S3)	0.958	0.869 0.981 0.836		0.836	0.965	0.852
	Off (S5)	0.628	0.506	0.623	0.512	0.624	0.509
	Zero Power Mode (EuP)	0.2	225	0.23		0.24	

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	60.	129	58.	969	70.611	
	Windows short Idle (S0)	65.	895	64.	64.309		974
	Windows Busy Typ (S0)	837	'.918	814.376		987.296	
	Windows Busy Max (S0)	939	939.835 910.287		.287	1029.821	
	Sleep (S3) 6.762 6.489		6.489	6.707	6.213	6.796	6.752
	Off (S5)	2.238	1.729	1.76	1.743	2.125	1.746
	Zero Power Mode (EuP)	0.7	771	0.794		0.75	

Example Configuration #5	Processor Info	CPU Xeon W-1250 3.3GHz 6C80W
	Memory Info	16GB (2x 8GB) 2666 MHz DDR4 ECC
	Graphics Info	RTX5000 Graphics
	Disks/Optical/Floppy	1x SATA 1TB SSD Z Turbo
	PSU	700W
	Other	

System Technical Specifications

Energy Consumption		115 VAC		230 VAC		100 VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows long Idle (S0)	17.	623	17.	283	17.	552	
	Windows short Idle (S0)	19.	313	18.848 238.68		18.846		
	Windows Busy Typ (S0)	24!	5.58			248.88		
	Windows Busy Max (S0)	27!	275.45		266.79		272.89	
	Sleep (S3)	0.958	0.869	0.981	0.836	0.965	0.852	
	Off (S5)	0.628	0.506	0.623	0.512	0.624	0.509	
	Zero Power Mode (EuP)	0.225		0.23		0.24		

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	60.129		58.969		59.887	
	Windows short Idle (S0)	65.	895	64.309 814.376 910.287		64.302	
	Windows Busy Typ (S0)	837	.918			849.178	
	Windows Busy Max (S0)	939	.835			931.101	
	Sleep (S3)	3.268	2.965	3.347	2.852	3.292	2.907
	Off (S5)	2.258	1.726	2.125	1.749	2.129	1.736
	Zero Power Mode (EuP) 0.767 0.784		784	0.818			

Operating Voltage Range 90-269 VAC **Rated Voltage Range** 100-240 VAC **Rated Line Frequency** 50-60 Hz **Operating Line Frequency** 47-66 Hz

Range

Rated Input Current 8.2A @ 100-240V (700W PSU)

> 6A @ 100-240V (500W PSU) 4.2A @ 100-240V (350W PSU)

Heat Dissipation Typical: 444 btu/hr (112 kcal/hr)

Maximum: 1484 btu/hr (374 kcal/hr)

Power Supply Fan 70mm x 70mm x 25mm 4-wire PWM

ENERGY STAR® certified Yes

(Config Dependent)

CECP Compliant @ 220V Yes

FEMP Standby Power Compliant

Yes, with Wake-on-LAN disabled: <1W in S4/S5 - Power Off

Built-in Self Test (BIST) LED Yes

Surge Tolerant Full Ranging Yes Power Supply (withstands

power surges up to 2000V)

Hood Lock Header

ErP Lot 6- Tier 1 Compliance Yes

@ 230V (<1W in S4/S5 -

Power Off)

ErP Lot 6- Tier 2 Compliance Yes

@ 230V (<0.5W in S4/S5 -

Power Off)

System Technical Specifications

Declared Noise Emissions (Entry-level, Mid-level, and High-end configurations; tested on floor)						
System Configuration Processor Info I5-10600 COMET LAKE G-0 6c 65W MS2 vPro® QS QTLR						
(Entry level)	Memory Info	4*Samsung 32GB 2933 nECC DIMM ¹				
	Graphics Info	Intel® UHD				
	Disks/Optical/PSU	Samsung PM871b 1TB 6Gb/s SSD / No Optical / Chicony 700W PSU				

Declared Noise Emissions (in accordance with ISO 7779 a		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
ISO 9296)	Idle	3.24	13.7
	Hard drive Operating (random reads)	3.44	16.9
	Hard drive Operating (active mode)	3.62	15.7

System Configuration (Entr	Processor Info	W-1250 COMET LAKE WS G-0 6c LGA 80W WE1 vPro® QS QTMD		
level)	Memory Info	4* Samsung 32GB 2933 nECC DIMM ¹		
	Graphics Info	NVIDIA® RTX5000		
	Disks/Optical /PSU	2*WD 2TB 7200RPM SATA HSS / No Optical / Lite-on 500W PSU		

Declared Noise Emissions (accordance with ISO 7779		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
and ISO 9296)	Idle	3.47	18.2
	Hard drive Operating (random reads)	3.75	20.4
	Hard drive Operating (active mode)	3.41	22.2

	Processor Info	19-10900 COMET LAKE WS P-1 10c LGA 2.8GHz 65W P2 vPro® QUBN
	Memory Info	4*Samsung 4*Samsung 32GB 2933 nECC DIMM ¹
	Graphics Info	Intel® UHD
	Disks/Optical /PSU	1 TB SATA 6Gb/s SSD / No Optical / Chicony 700W PSU

		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.24	13.5
	Hard drive Operating (random reads)	3.39	15.8
	Hard drive Operating (active mode)	3.49	15.9

System Configuration (Mid- level)	Processor Info	W-1290 COMET LAKE WS P-1 10c 3.2G LGA 80W WE3 vPro® QSK QS QUBT
	Memory Info	4* Samsung 32GB 2933 nECC DIMM ¹
	Graphics Info	NVIDIA® RTX5000
	Disks/Optical /PSU	2*WD 2TB 7200RPM SATA HSS / No Optical / Lite-on 500W PSU

System Technical Specifications

		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.55	16.9
	Hard drive Operating (random reads)	3.72	19.9
	Hard drive Operating (active mode)	3.43	21.5

System Configuration (High end)	-Processor Info	I9-10900K COMET LAKE WS P-1 10c LGA 3.7GHz 125W P2K vPro® QUBQ	
	Memory Info	4* Samsung 32GB 2933 nECC DIMM ¹	
	Graphics Info	NVIDIA® RTX5000	
	Disks/Optical/PSU	2*WD 2TB 7200RPM SATA HSS / No Optical / Lite-on 500W PSU	

Declared Noise Emissions (accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.50	18.3
	Hard drive Operating (random reads)	3.88	20.6
	Hard drive Operating (active mode)	3.88	20.8
	Note 1: Transfer rates up	to 2933MT/s.	

Environmental Requirements	Temperature	Operating: 5° to 35° C (40° to 95° F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F) Maximum rate of change: 10°C/hr
	Humidity	Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb
	Maximum Altitude	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Temperature for details.
	Shock (non-repetitive)	Operating ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating ½-sine: 160 cm/s, 2-3 ms (~105 g) Non-operating square: 422 cm/s, 20 g
	Vibration	Operating random: 0.5 g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0 g (rms), 5-500 Hz, up to 0.0150 g²/Hz

System Technical Specifications

Physical Security and Serviceability

Access Panel Tool-less

Includes system board and memory information

Optical Drive Tool-less, except for Screw-In carrier

Hard Drives Tool-less, except for 2.5" bay

Expansion Cards Tool-less

Processor Socket Tool-less, except for the processor heatsink

Blue User Touch Points Yes. on tool-less internal chassis mechanisms

Color-coordinated Cables

and Connectors

MemoryTool-lessSystem BoardScrew-In

Padlock Support Yes (optional): Locks side cover and secures chassis from theft

0.22-in diameter padlock loop at rear of system

Cable Lock Support Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft

3 mm x 7 mm slot at rear of system

Universal Chassis Clamp

Lock Support

Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple u

be chained together when used with optional cable

Threaded feature at rear of system

Solenoid Lock and Hood

Sensor

Yes (optional)
The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software.

a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects whe

access panel has been removed.

Rear Port Control Cover No

CPUs and Heatsinks

A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed.

removal is tool-less

Internal Speaker Yes

Power Supply Fans 70mm x 70mm x 25mm 4-wire PWM (non-serviceable)

Access Panel Key Lock No

Integrated Chassis Handles Rear Recessed Handle

Power Supply Requires T-15 Torx or flat blade screwdriver

PCI Card Retention Yes, rear (all), middle (optional), front (full-length cards with extender)

System Technical Specifications

Social and Environmental Responsibility

Declarations

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be labeled one or more of these marks:

- ENERGY STAR® (energy-saving features available on select configurations-Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- IT ECO declaration

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/o components contained in the product may include:

- 3 USB ports
- 1 PC card slot (type I/II)
- 1 ExpressCard/54 slot
- 1 IEEE 1394 Port
- 2 SODIMM memory slots
- Optional expansion base docking station
- 1 multi-bay II storage port
- Interchangeable HDD

Spare parts are available throughout the warranty period and or for up to "5"? years after the end of product

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC Batteries used in the product do not contain:

Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Restricted Material Usage This product meets the material restrictions specified in HP's General Specification for the Environment.

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf

HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the Euro Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.

End-of-Life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle you product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclab weight when properly disposed of at end of life.

HP Inc. Corporate

For more information about HP's commitment to the environment:

Environmental Information Living Progress Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configurate stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section. HP Stable & Consistent Offerings are available worldwing all HP Workstation customers—no special programs, no additional cost—no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering
		Intel Core i3-10100 3.6 4C 65W processor
		Intel Core i5-10500 3.1 6C 65W processor
		Intel Core i5-10600 3.3 6C 65W processor
		Intel Core i7-10700 2.9 8C 65W processor
		Intel Xeon W-1250 3.3 6C 80W processor
		Intel Xeon W-1250P 4.1 6C 125W processor
Hard Drives	Product #	Offering
		1TB 7200RPM SATA 3.5 HDD
Graphics	Product #	Offering
		AMD Radeon TM Pro WX 3200 4GB

Technical Specifications - Processors

10th Generation Intel Core Processors

Intel® CoreTM i9-10900K Processor

Intel® CoreTM i9-10900 Processor

Intel® CoreTM i9-10900F Processor¹

Intel® CoreTM i7-10700K Processor

Intel® CoreTM i7-10700 processor

Intel® CoreTM i5-10600K processor

Intel® CoreTM i5-10600 processor

Intel® CoreTM i5-10500 processor

Intel® CoreTM i5-10400 processor

Intel® CoreTM i5-10400F Processor¹

Intel® CoreTM i3-10320 processor¹

Intel® CoreTM i3-10300 processor¹

Intel® CoreTM i3-10100 processor

Intel Xeon W Processors

Intel Xeon W-1290P processor

Intel Xeon W-1290 processor¹

Intel Xeon W-1270P processor¹

Intel Xeon W-1270 processor

Intel Xeon W-1250P processor

Intel Xeon W-1250 processor

NOTE 1: Available in Q4, 2020

Technical Specifications - Hard Drives

SATA Hard Drives for HP Workstations

500GB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity500GBProtocolSATAForm Factor3.5"ControllerAHCI

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s *

Rate (Maximum)

Buffer 32MB

Seek Time (typical reads, Single Track 2 ms * includes controller overhead Average including settling)

Full Stroke 2 ms *

Rotational Speed 7,200 rpm Logical Blocks 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1TB
Protocol SATA
Form Factor 3.5"
Controller AHCI
Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600 MB/s *

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, Single Track includes controller Average overhead, including settling)

Full Stroke 2 ms *

2 ms *

11 ms *

2 ms *

Rotational Speed 7,200 rpm **Logical Blocks** 1,953,525,168

Operating Temperature 41° to 131° F (5° to 55° C)

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

2TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 2TB
Protocol SATA
Form Factor 3.5"
Controller AHCI
NAND Type 3D TLC

Endurance 400TBW (TB Written)

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Up to 600MB/s *

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, Single Track includes controller Average overhead, including settling)

Full Stroke 2.0 ms * 11 ms * 2.0 ms *

Rotational Speed 7,200 rpm Logical Blocks 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) Capacity 1TB

Height 1 in; 2.54 cm

Protocol SATA
Form Factor 3.5"
Controller AHCI

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Up to 600MB/s *

Rate (Maximum)

Buffer 128MB

Seek Time (typical reads, Single Track includes controller Average overhead, including settling) 7.45ms*

Full Stroke 14.2ms*

Rotational Speed 7,200 rpm Logical Blocks 3,907,029,168

Operating Temperature 41° to 140° F (5° to 60° C)

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

1TB SATA 7200 rpm 6Gb/s Capacity 1TB 3.5" HDD (Enterprise Class)_{Protocol} SATA

Form Factor 3.5"
Controller AHCI

Reliability (MTBF) 2.0M hours
Rated Power On Hours 8760/yr
Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365

operation

Physical Size (Height)1 in; 2.54 cmPhysical Size (Width)4 in; 10.17 cmMedia Diameter3.5 in; 8.9 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer Rate (Maximum)

Up to 600MB/s*

Buffer 128MB
Cache Adaptive

Seek Time (typical reads, Single Track includes controller Average overhead, including settling)

Average 7.45ms* ing) Full Stroke 14.2ms*

Rotational Speed 7,200 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s*

Sequential Write up to 226MB/s*

0.32ms*

Enterprise Class Features High Reliability

*Actual performance may vary.

2TB SATA 7200 rpm 6Gb/s Capacity 2TB
3.5" HDD (Enterprise Class) Protocol SATA

Form Factor 3.5"
Controller AHCI

Reliability (MTBF) 2.0M hours
Rated Power On Hours 8760/yr
Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365

Operation

Physical Size (Height)1 in; 2.54 cmPhysical Size (Width)4 in; 10.17 cmMedia Diameter3.5 in; 8.9 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Technical Specifications - Hard Drives

Synchronous Transfer RateUp to 600MB/s*

(Maximum)

Buffer 128MB

Seek Time (typical reads, Single Track includes controller overhead verage including settling)

Full Stroke 0.7ms*

8.5ms*

Operating Temperature 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s*

Sequential Write up to 226MB/s*

Enterprise Class Features High Reliability

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) Capacity 4TB
Protocol SATA
Form Factor 3.5"
Controller AHCI

Reliability 2.0M hours
Rated Power On Hours 8760/yr
Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365

Operation

Physical Size (Height)1 in; 2.54 cmPhysical Size (Width)4 in; 10.17 cmMedia Diameter3.5 in; 8.9 cmPhysical Size4 in; 10.17 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer Rate (Maximum)

Transfer Up to 600MB/s*

Nate (Maximum)

Buffer 256MB

Seek Time (typical reads,Single Track includes controller Average overhead, including settling)

Full Stroke 0.7ms*

8.5ms*

Operating Temperature41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s*

Sequential Write up to 226MB/s*

Enterprise Class Features High Reliability

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

8TB SATA 7200 rpm 6Gb/s Capacity 3.5" HDD (Enterprise Class) Protocol

Capacity 500GB
Protocol SATA
Form Factor 3.5"
Controller AHCI
Reliability 2.0M hours

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s [1]

Rate (Maximum)

Buffer 256MB

Seek Time (typical reads, Single Track includes controller overhead Average including settling)

Full Stroke 0.7ms*

8.5ms*

15.7ms*

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

Performance Sequential Read up to 226MB/s¹

Sequential Write up to 226MB/s¹

Enterprise Class Features High Reliability

500GB SATA 7.2K SED 2.5" Capacity HDD

Capacity 500GB
Protocol SATA

Form Factor 2.5"

Height 0.275 in; 0.7 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Rate Up to 600MB/s*

(Maximum)

Buffer 64MB

Seek Time (typical reads, Single Track 1ms* includes controller overhead Average 4.2ms*

including settling)

Full Stroke 25ms (Typical)*

Rotational Speed 7,200 rpm

Operating Temperature 32° to 131° F (0° to 60° C)

Self-Encrypting Drive Yes

Support

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP 256GB SATA 6Gb/s

SSD

Capacity 256GB
Protocol SATA
Form Factor 2.5"

Height0.28 in; 0.7 cmWidthPhysical Size

Synchronous Transfer Rate Up to 550MB/s (Sequential Read)*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

*Actual performance may vary.

HP 512GB SATA 6Gb/s SSD Capacity 512GB
Protocol SATA
Form Factor 2.5"

Height0.28 in; 0.7 cmWidthPhysical SizeInterface6Gb/s SATA

Synchronous Transfer Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

1TB

*Actual performance may vary.

HP 1TB SATA 6Gb/s SSD Capacity

Protocol SATA
Form Factor 2.5"

Height 0.28 in; 0.7 cm
Width Physical Size
Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

*Actual performance may vary.

HP 1TB SATA 6Gb/s SSD Capacity 1TB

Height 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

*Actual performance may vary.

Technical Specifications - Hard Drives

HP 2TB SATA 6Gb/s SSD

2TB Capacity **SATA Protocol** 2.5" **Form Factor**

Height 0.28 in; 0.7 cm Width **Physical Size** SATA 6Gb/s Interface

Synchronous Transfer Rate Up to 550MB/s (Sequential Read)*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SED Opal 2 SSD

Capacity 256GB **Protocol** SATA 2.5" **Form Factor**

Height 0.28 in; 0.7 cm Width **Physical Size** Interface SATA 6Gb/s

Synchronous Transfer Rate Up to 550MB/s (Sequential Read)*

OPAL2

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Self-Encrypting Drive

Support

HP 512GB SATA 6Gb/s SED Opal 2 SSD

Capacity 512GB **Protocol** SATA **Form Factor** 2.5"

Endurance 400TBW (TB Written)

Reliability 1.5M Hours Height 0.28 in; 0.7 cm Width **Physical Size**

Synchronous Transfer Rate Up to 550MB/s (Sequential Read)*

(Maximum)

32° to 158° F (0° to 70° C) **Operating Temperature**

Self-Encrypting Drive OPAL2

Support

^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP Z Turbo Drv 256GB TLC Capacity
PCIe SSD (Z2G5)

Protocol

Capacity 256GB Protocol PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

Endurance 75TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 3.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 2800MB/s*

Sequential Write 1100MB/s*
Random Read 250K IOPS*
Random Write 180K IOPS*

HP 256GB SATA 6Gb/s SED Opal 2 SSD Capacity 256GB Protocol PCIe

Form Factor M.2 in native slot on motherboard

Controller NVMe
NAND Type 3D TLC

Endurance 200TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2200 *

Random Read 240K IOPS*

Random Write 480K IOPS*

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP Z Turbo Drv 512GB TLC PCIe SSD (Z2G5) Capacity 512GB Protocol PCle

Form Factor M.2 in native Slot on motherboard

Controller NVMe
NAND Type 3D TLC

Endurance 150TBW (TB Written)

Reliability (MTBF) 1.5M hours

InterfacePCI Express 3.0 x4 electricalOperating Temperature32° to 158° F (0° to 70° C)

Performance Sequential Read 2800MB/s*

Sequential Write 1600MB/s*
Random Read 260K IOPS*
Random Write 260K IOPS*

HP Z Turbo Drv 1TB TLC PCIe SSD (Z2G5)

Capacity 1TB
Protocol PCle

Form Factor M.2 in native Slot on motherboard

Controller NVMe
NAND Type 3D TLC

Endurance 300TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 3.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3000MB/s*

Sequential Write 1700MB/s*
Random Read 360K IOPS*
Random Write 330K IOPS*

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP Z Turbo Drv 2TB TLC PCIe SSD (Z2G5) Capacity 2TB
Protocol PCle

Form Factor M.2 in native Slot on motherboard

Controller NVMe
NAND Type 3D TLC

Endurance 600TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 3.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3000MB/s*

Sequential Write 2100MB/s*
Random Read 320K IOPS*
Random Write 265K IOPS*

HP Z Turbo Drv 256GB Capacity TLC PCIe SED OPAL2 (Z2G5) Protocol

Capacity 256GB Protocol PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe
NAND Type 3D TLC

Endurance 75TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 3.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 2800MB/s*

Sequential Write 1100MB/s*
Random Read 250K IOPS*
Random Write 180K IOPS*

Self-Encrypting Drive

Support

OPAL2

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP Z Turbo Drv 512GB TLC PCIe SED OPAL2 (Z2G5) Protocol

512GB Capacity PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe **NAND Type** 3D TLC

150TBW (TB Written) **Endurance**

Reliability 1.5M Hours

Interface PCI Express 3.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

Performance Sequential Read 2800MB/s*

> **Sequential Write** 1600MB/s* **Random Read** 260K IOPS* **Random Write** 260K IOPS*

Self-Encrypting Drive

Support

OPAL2

*Actual performance may vary.

HP Z Turbo Drv 1TB TLC PCIe SED OPAL2 (Z2G5) Protocol

Capacity 1TB PCIe

M.2 in native Slot on motherboard **Form Factor**

Controller NVMe **NAND Type** 3D TLC

Endurance 300TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 3.0 x4 electrical 32° to 158° F (0° to 70° C) **Operating Temperature**

Performance Sequential Read 3000MB/s*

> **Sequential Write** 1700MB/s* **Random Read** 360K IOPS* **Random Write** 330K IOPS*

Self-Encrypting Drive

Support

OPAL2

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP Z Turbo Drv 2TB Capacity TLC PCIe SED OPAL2 (Z2G5) Protocol

Capacity 2TB
Protocol PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe
NAND Type 3D TLC

Endurance 600TBW (TB Written)

Reliability 1.5M Hours

InterfacePCI Express 3.0 x4 electricalOperating Temperature32° to 158° F (0° to 70° C)

Performance Sequential Read 3000MB/s*

Sequential Write 2100MB/s*
Random Read 320K IOPS*
Random Write 265K IOPS*

Self-Encrypting Drive

Support

OPAL2

UPALZ

^{*}Actual performance may vary.

Technical Specifications - Graphics

Integrated Intel® UHD Graphics (Z2 G5) **Form Factor** Integrated in select Intel® Xeon® E, Intel® CoreTM i7, and Intel® CoreTM i5

processors.

Check specific platform specifications for selections.

Graphics Controller Intel® UHD Graphics

Memory Unified Memory Architecture (UMA) frame buffer. Graphics memory is shared

with system memory. Size selectable between 64 MB to 1024 MB via BIOS setting. Default size is 64 MB. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (Intel® DVMT 5.0), to provide an optimal balance between graphics and system memory use.

Connectors Check system platform specifications where Intel® UHD Graphics are available.

Maximum Resolution Display Port: 4096 x 2160

HDMI: 4096 x 2160 DVI: 1920x1200 VGA: 2048x1536

NOTE: For HDMI, DVI and VGA outputs, separate adapters may be required.

Shading Architecture Shader Model 6 compiler support

Supported Graphics APIs OpenGL 4.54

DirectX 12

Available Graphics Drivers Windows 10

NVIDIA® Quadro® P400 2GBForm Factor Single Slot, Low Profile (2.713"? H x 5.7"? L)

Graphics

Graphics Controller NVIDIA® Quadro® P400 Graphics Card

Max Power: 30 Watts

Cooling Solution: Active fan heatsink

Bus TypePCI Express 3.0 x16MemorySize: 2 GB GDDR5

Maximum Resolution DisplayPortTM 1.4:

up to 3x 5120 x 2880 x 24 bpp @ 60Hz
 supports Multi-Stream Transport (MST)
 mDP (Mini DisplayPortTM) 1.4 Connectors

Display Output 3 mDP (Mini DisplayPort[™]) 1.4 Connector **Shading Architecture** Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes: CUDA, OpenCL 1.x

Available Graphics Drivers Microsoft Windows 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes *P400, P620 and P1000 only have mini-DisplayPortTM> (mDP) video ports.

Note 1: AMO kits for P400, P1000 and Adapters

Technical Specifications - Graphics

- Two mDP-to-DP Adapters are included in the P400, P620 and P1000 AMO kits.
- If more mDP-to-DP Adapters are needed, Adapters can be ordered separately:

- 2MY05AA HP Single miniDP-to-DP Adapter Cable

- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® Quadro® P620 2GB Graphics Form Factor Single slot, Low Profile (2.713"? H x 5.7"? L)

Graphics Controller NVIDIA® Quadro® P620 Max. Power: 40W

Cooling Solution: Active fan heatsink

Bus TypePCI Express x16MemorySize: 2GB DDR5Maximum ResolutionDisplayPort™ 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

Display Outputs 4 mDP (Mini DisplayPortTM) 1.4 Connectors

Supported Graphics APIs

OpenGL 4.5 DirectX 12 Vulkan 1.0

API support includes: CUDA, OpenCL 1.x

Available Graphics Drivers

Microsoft Windows 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

*P400, P620 and P1000 only have mini-DisplayPortTM (mDP) video ports.

Note 1: AMO kits for P400, P620, P1000 and Adapters

 Two mDP-to-DP Adapters are included in the P400, P620 and P1000 AMO kits.

 If more mDP-to-DP Adapters are needed, Adapters can be ordered separately:

2MY05AA HP Single miniDP-to-DP Adapter Cable

- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Technical Specifications - Graphics

AMD RadeonTM Pro WX 3200 Form Factor

4GB Graphics

Low-Profile Single Slot (2.75 "H x 6.6"? L)

RadeonTM Pro WX 3200 Power: 56 Watts

Cooling Solution: Active fan heatsink

4GB GDDR5 memory Memory DisplayPortTM 1.4: **Maximum Resolution**

Graphics Controller

- up to 4x 4096 x 2160 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1 4 mDP (Mini DisplayPort[™]) 1.4 Connectors **Display Outputs**

Supported Graphics APIs DirectX® 12

OpenGL® 4.6 OpenCLTM 2.0 VulkanTM 1.0

Available Graphics Drivers Windows 10 64-bit

> (Windows® 7 64-bit available from AMD) Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web site http://welcome.hp.com/country/us/en/support.html

Notes

- HDR content requires that the system be configured with a fully HD ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content require operating system support.
- WX 3200 only has mini-DisplayPortTM (mDP) video ports. Two mDF to-DP Adapters are included in the WX 3200 AMO kit. If more mDP-DP Adapters are needed, Adapters can be ordered separately:
- 2MY05AA HP Single miniDP-to-DP Adapter Cable
- 2KW87A6 HP (Bulk 12) miniDP-to-DP Adapter Cables

AMD Radeon[™] Pro W5500 Form Factor **8GB Graphics**

Single slot, full-height, 9.5"? length

RadeonTM Pro W5500 **Graphics Controller** Power: 120 Watts

Cooling Solution: Active Fan Heatsink

8GB GDDR6 Memory DisplayPortTM 1.4: **Maximum Resolution**

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz supports Multi-Stream Transport (MST)

DisplayPortTM 1.4 Connectors **Display Outputs**

FreeSync support

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

DirectX[®] 12 (12_1) OpenGL[®] 4.6 OpenCLTM 2.0 **Supported Graphics APIs**

VulkanTM 1.1

Available Graphics Drivers Windows 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web site http://welcome.hp.com/country/us/en/support.html



Technical Specifications - Graphics

NVIDIA® Quadro® P1000 4GB Graphics **Form Factor** Single Slot, Low Profile, Dimensions:2.713"? H x 5.7"? L

Cooling: Active

Graphics Controller NVIDIA® Quadro® P1000

47 Watts

Cooling Solution: Active Fan Heatsink

Bus Type PCI Express 3.0 x16 **Maximum Resolution** DisplayPortTM 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz- supports Multi-Stream Transport (MST)

Display Output 4 mDP 1.4 Connectors

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.5
Direct V 12

DirectX 12 Vulkan 1.0

API support includes: CUDA, OpenCL 1.x

Available Graphics Drivers Microsoft Windows 10

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes *P400, P620 and P1000 only have mini-DisplayPortTM (mDP) video ports.

Note 1: AMO kits for P400, P620, P1000 and Adapters

 Two mDP-to-DP Adapters are included in the P400, P620 and P1000 AMO kits.

 If mDP-to-DP Adapters are needed, Adapters can be ordered separately:

- 2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables

- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Technical Specifications - Graphics

NVIDIA® Ouadro® P2200 **5GB Graphics**

Form Factor Single Slot, Full Height (4.4"?H x 7.9"?L)

Weight: 260 grams

NVIDIA® Ouadro® P2200 **Graphics Controller**

Power: 75 Watts

Cooling Solution: Active Fan Heatsink

Bus Type PCI Express 3.0 x16

Memory **5GB GDDR5X**

DisplayPortTM 1.4: **Maximum Resolution**

> - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

4 DisplayPortTM 1.4 **Display Output**

Full Microsoft DirectX 12 Shader Model 5.1 **Shading Architecture**

OpenGL® 4.5 **Supported Graphics APIs**

DirectX[®] 12 Vulcan 1.0

API support includes: CUDA, OpenCL 1.x

Available Graphics Drivers Microsoft Windows 10

Linux®-64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

AMD RadeonTM Pro W5700 Form Factor **8GB Graphics**

Full-Height Dual Slot (10.5"? Length)

RadeonTM Pro W5700 **Graphics Controller** Power: 210 Watts

Cooling Solution: Active Fan Heatsink

8GB GDDR6 Memory DisplayPortTM 1.4: **Maximum Resolution**

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Display Output 4 DisplayPortTM 1.4 Outputs

FreeSync support

Supported Graphics APIs DirectX[®] 12 (12_1)

OpenGL® 4.6 OpenCLTM 2.0 VulkanTM 1.0

Available Graphics Drivers Windows 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web site

http://welcome.hp.com/country/us/en/support.html

Technical Specifications - Graphics

NVIDIA® Quadro® RTX Form Factor 4000 8GB Graphics Graphics Col

Form Factor Full-Height Single Slot (4.4"? Height x 9.5"? Length)

Graphics Controller NVIDIA® Quadro® RTX 4000 Power: 160 Watts

Cooling Solution: Active Fan Heatsink

 Memory
 8GB GDDR6

 Maximum Resolution
 DisplayPort™ 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Display Outputs¹ 3x DisplayPortTM1.4a and VirtualLink²

Supported Graphics APIs DirectX[®]12, OpenGL[®] 4.5, OpenCLTM 1.0, VulkanTM 1.0 Additional API support includes: CUDA OpenCLTM 1.x

Available Graphics Drivers Windows® 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

2- VirtualLink's USB-CTM (data) cannot be disabled at a hardware level

NVIDIA® Quadro® RTX 5000 16GB Graphics **Form Factor** Full-Height Dual Slot (4.4"? Height x 10.5"? Length)

Graphics Controller NVIDIA® QUADRO® RTX 5000

Power: 265 Watts

Cooling Solution: Active Fan Heatsink

 Memory
 16GB GDDR6

 Maximum Resolution
 DisplayPort™ 1.

Maximum Resolution DisplayPort™ 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Display Outputs 4x DisplayPortTM 1.4 and VirtualLink²

Supported Graphics DirectX®12, OpenGL® 4.5

APIs Additional API support includes: CUDA, OpenCLTM

Available Graphics Windows® 10 64-bit

Drivers Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured: No adapters included After market option kit: No adapters included

*VirtualLink's USB-CTM (data) cannot be disabled at a hardware level

Technical Specifications - Graphics

NVIDIA® Quadro® RTX Form Factor 6000 24GB Graphics

Form Factor Full-Height Dual Slot (4.4"? Height x 10.5"? Length)

Graphics Controller NVIDIA® QUADRO® RTX 6000

Power: 295 Watts

Cooling Solution: Active Fan Heatsink

Memory 24GB GDDR6

Maximum Resolution DisplayPortTM 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz- supports Multi-Stream Transport (MST)

Display Outputs 4x DisplayPort[™] 1.4 and VirtualLink²

Supported Graphics

APIS

DirectX®12, OpenGL® 4.5, Vulcan 1.0

Additional API support includes: CUDA, OpenCLTM 1.x

Available Graphics

Drivers

Windows® 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured: No adapters included
After market option kit: No adapters included

*VirtualLink's USB-CTM (data) cannot be disabled at a hardware level

Technical Specifications - Optical and Removable Storage

HP 9.5mm Slim DVD Writer Description 9.5mm height, tray-load

> Either horizontal or vertical **Mounting Orientation**

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD+R

> DVD+RW DVD+R DL DVD-R DL DVD-R **DVD-RW** CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Access Times < 200 ms (seek) **Full Stroke DVD**

> **Full Stroke CD** < 200 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

> DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

SATA DC power receptacle **Power** Source

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -< 800 mA typical, <1600 mA maximum

41° to 122° F (5° to 50° C)

Operating Environmental Temperature

(all conditions non-

condensing)

Relative Humidity 10% to 80%

Maximum Wet Bulb 84° F (29° C)

Temperature

Operating Systems

Supported

Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000.

Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation

SUSE Linux® Enterprise Desktop 12

Kit Contents HP SATA DVD Writer drive, installation guide.

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0,

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-

Tick, VCCI, MIC, cUL, TUVT

Technical Specifications - Optical and Removable Storage

HP 9.5mm Slim DVD-ROM Drive

Description 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA / ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB

Double layer: Up to 8.5 GB

Access Times DVD-ROM Single Layer < 110 ms (typical)

CD-ROM Mode 1 < 110 ms (typical)

Full Stroke DVD < 230 ms (typical)

Full Stroke CD < 220 ms (typical)

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC – <800mA typical, < 1600 mA maximum

Operating Environmental Temperature

(all conditions non-

condensing)

Temperature 41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80% **Maximum Wet Bulb** 84° F (29° C)

Temperature

Operating Systems

Supported

Windows 10, Windows 7 Professional 64-bit,

Windows Vista Business 64*, Windows 2000.

Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation

SUSE Linux® Enterprise Desktop 12

Kit Contents 9.5mm Slim DVD-ROM Drive, slim SATA data/power cable, installation guide

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0,

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-

Tick, VCCI, MIC, cUL, TUVT

HP 9.5mm Slim BDXL Blu-Ray Writer

Description9.5mm height, tray-loadMounting OrientationEither horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types BD-ROM

BD-R BD-RE DVD-RAM DVD+R DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Technical Specifications - Optical and Removable Storage

Disc Capacity **DVD-ROM** 8.5 GB DL or 4.7 GB standard

> Blu-ray 25 GB (single-layer)

50 GB (dual-layer) 100/128 GB (BDXL)

Access Times Full Stroke DVD < 230 ms (seek)

> **Full Stroke CD** < 220 ms (seek)

Blu-ray < 230 ms (seek) (Full Stroke Blu-ray)

Startup Time (Time to drive ready from tray loading)

> BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 255 / 285 BD-RE (SL/DL) 255 / 285 DVD-ROM (SL/DL) 18S / 18S 25S / 25S DVD-R (SL/DL)

DVD-RW **25S**

DVD+R (SL/DL) 255 / 255

DVD+RW 255 DVD-RAM **45S** CD-ROM **15S**

Maximum Data Transfer

Rates

CD ROM Read

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD-RAM Up to 8X

> DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Blu-ray BD-ROM Up to 6X

> BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -900 mA typical, 2000mA maximum

Operating Environmental Temperature

(all conditions noncondensing)

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80% **Maximum Wet Bulb**

84° F (29° C)

Temperature

Operating Systems

Supported

Windows 10, Windows 7 Professional 64-bit,

Windows Vista Business 64*, Windows 2000.

Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation

SUSE Linux® Enterprise Desktop 12

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

Technical Specifications - Optical and Removable Storage

Technical Specifications - Controller Cards

HP ThunderboltTM 3 PCIe 3 Data Transfer Rate
Dual-port I/O Card Davisos Supported

Data Transfer Rate Supports up to 40 Gb/s 40,000 Mb/s)

Devices Supported Thunderbolt[™] certified devices

Bus Type PCIe card, full height PCIe slots

Ports One USB 3.1 Type-C[®] connector (Rear)

Internal Connectors One wire-to-board-connector

System Requirements Windows 10 RS3 64-bit, Intel® i5 series or higher processor, 4-GB RAM, 20-GB H

Drive, available PCIe slot.

Temperature - Operating 50° to 131° F (10° to 55° C)

Temperature - Storage -22° to 140° F (-30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiw

BSMI CNS13438, Korea MIC

Operating Systems

Supported

-Windows 10 RS3 64-bit.

Kit Contents HP ThunderboltTM 3 PCIe 3-port I/O Card, full height bulkhead bracket, DisplayPo

and GPIO (General-Purpose Input/Output) cable, Installation documentation and

warranty card.

Technical Specifications - Networking and Communications

Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro® with Intel® AMT 12.0) **Connector** RJ-45

Controller Intel® I219LM GbE platform LAN connect networking controller

Memory 3 KB Tx and 3KB Rx FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3z

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCIe-based interface for active state operation (S0 state) and SMBus for host and

management traffic (Sx low power state)

Power Requirement Requires 3.3V (integrated regulators for core Vdc)

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities vPro®, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI, Advanced

cable diagnostic, loopback modes,

AMT 12.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery (MLD)

Intel® X710-DA2 2-Port SFP+ 10GbE NIC **Connector** 2 SFP+ Ports

Cabling Twin Axial Cabling up to 10m

Controller Intel® Ethernet Controller X710-AM2

Network Transfer Rates

Supported

10GbE (with supported 10GBASE-SR transceivers)

Data Path Width PCIe Gen3x8 (compatible with x4)

Power Requirement 4.3W (typical) (with supported 10GBASE-SR transceivers)

Operating Temperature32° to 131° F (0° to 55° C)Dimensions (HxW)2.703 x 6.578 inches

Operating System Driver

Support

Windows 10 64-bit

Linux®

Kit Contents

Intel® X710-DA2 2-Port SFP+ 10GbE NIC with standard

height bracket attached

Low-profile bracket

Product Literature

Technical Specifications - Networking and Communications

HP 10GbE SFP+ SR Transceiver

Operating Temperature 32°F to 113°F (0°C to 45°C) **Operating Humidity** 0% to 85%, noncondensing Dimensions (HxWxD) 0.47 x 0.54 x 2.19 inches

Kit Contents HP 10GbE SFP+ SR Transceiver

Intel® X550-T2 2-Port **10GbE NIC**

Connector 2 RJ-45

Cabling 10GbE: Cat6a (or better) up to 100m

5GbE and below: Cat5e (or better) up to 100m

Controller Intel® Ethernet Controller X550

Network Transfer Rates

Supported

10GbE, 5GbE, 2.5GbE, 1GbE, 100MbE

Data Path Width PCIe Gen3x4 **Power Requirement** 11.2W (typical)

Operating Temperature 32° to 131° F (0° to 55° C) **Dimensions** (HxW) 5.1 x 2.7 in (without brackets)

Operating System Driver

Support

Windows 10 64-bit

Linux®

Kit Contents Intel® X550-T2 2-Port 10GbE NIC with standard height

> bracket attached Low-profile bracket

Product Literature

Aquantia® AQN-108 1-Port Connector **5GbE NIC**

1 RJ-45

Cabling Cat5e (or better) up to 100m

Aquantia® AQC108 **Controller**

Network Transfer Rates

Power Requirement

Supported

5Gbe, 2.5GbE, 1GbE, 100MbE

Data Path Width

PCIe Gen3x1 3.5W (typical)

Operating Temperature 32° to 131° F (0° to 55° C)

Dimensions (HxW) 3.72 x 3.18 inches (without brackets) **Operating System Driver** Windows 7 64-bit; Windows 10 64-bit;

Support

Linux®

Kit Contents

Aquantia AQN-108 1-Port 5GbE NIC with standard height

bracket attached Low-profile bracket

Product Literature

Technical Specifications - Networking and Communications

Intel® 1350-T2 2-Port 1GbE Connector

NIC

2 RJ-45

Cabling Cat5e (or better) up to 100m Controller Intel® Ethernet I350 Controller

Network Transfer Rates

Supported

1GbE, 100MbE, 10MbE

Data Path Width PCle Gen2.1x4 **Power Requirement** 4.4W (typical)

32° to 131° F (0° to 55° C) **Operating Temperature**

Dimensions (HxW) 2.75 x 5.5 inches (without brackets) **Operating System Driver** Windows 7 64-bit: Windows 10 64-bit:

Support

Kit Contents

Linux®

Intel® I350-T2 2-Port 1GbE NIC with standard height

bracket attached Low-profile bracket Product Literature

Intel® 1350-T4 4-Port 1GbE Connector NIC

4 RJ-45

Cabling Cat5e (or better) up to 100m Controller Intel® Ethernet I350 Controller

Network Transfer Rates

Supported

1GbE, 100MbE, 10MbE

Data Path Width PCle Gen2.1x4 **Power Requirement** 5W (typical)

32° to 131° F (0° to 55° C) **Operating Temperature**

Dimensions (HxW) 2.75 x 5.5 inches (without brackets) **Operating System Driver** Windows 7 64-bit; Windows 10 64-bit;

Support

Linux®

Kit Contents

Intel® I350-T4 4-Port 1GbE NIC with standard height

bracket attached Low-profile bracket Product Literature

Intel® AX201 802.11 a/b/g/n/ac/ax WLAN + Bluetooth 5.0 M.2

WLAN Standards

802.11a/b/g/n/ac/ax Wave 6, Dual band 2x2 with up to 2.4Gbps speed (theoretic maximum); Up to 3x faster than 802.11ac and up to 4x capacity in congested

environments than 802.11ac

Antenna 2x2 Dual-Band

Bluetooth Standards 5

Operating Temperature 32° to 131° F (0° to 55° C)

Interface M.2 CNVio **Dimensions** M.2 2230 **Kit Contents** Not Available

NOTE: Wireless access point and internet service required and sold separately. Availability of public wireless points limited. Wi-Fi 5 (802.11 ax) is backwards compatible with prior 802.11 specs.

Technical Specifications - Other Hardware

HP eSATA PCI Cable Kit

Part Number

FH966AA

Features

- 1x eSATA ports
- Bring the same ultra-fast SATA performance that you demand from your internal SATA hard drives to an external eSATA hard drive.
- Faster transfer rates than existing external storage solutions: USB 2.0 & 1394.
- Complete motherboard to eSATA PCI bracket solution.
- Robust and user friendly external eSATA connector.

Z2 G5 TWR Bezel w/ Dust **Filter option**

Part Number

Overview

4KY89AA

Workstations are deployed in a variety of different ways and in different environments, from under a desk to manufacturing floors. HP Workstations designed a dust filter option to further protect the system against the ingress o and other particles over the life of the system. Test have shown a reduction of d ingress of up to 32% for the HP Z2 Tower G5 Workstation platform and is cleanal and serviceable by customers. There is also a BIOS setting that will warn custom when it is time to check and clean their filters.

dust filter

Cleaning and servicing the After removing the filter from the system bezel (dust filter can be removed with the use of tools from the front bezel), either blow it with and wash with water o a delicate duster (feather duster) to brush off the filter then rinse it with water.

- Allow the filter half a day to dry at room temperature (25C at 30%-50% humidit
- Temperature of water can be 0-70C, due to the dust filter meeting the SQTM 70C humidity test. Suggested water temperature for best user experience is 0-50C.
- Normal tap water (and most other types of water) can be used to rinse the filter. Any type of corrosive liquid is restricted.

Enabling the Check Filtef. warning in the BIOS:

Customers must enable the BIOS setting once they receive their filter.

- To enable, do the following once you see the boot screen for your system: F10 > Advanced > Built-In Device Options > Dust Filter
- Select to enable the Dust Filter replacement reminder, which can be set for 15, 3 60, 90, 120, or 180 days. The Reminder will show during POST after the reminde timer has expired.

4.

NOTE: customers who anticipate more dust ingress in their environments shoul the reminder for a shorter window. Customers anticipating longer ingress can so the reminder for a longer window.

BIOS Warnings

Large enterprise customers deploying multiple systems can centrally enable/co the BIOS warning using the WMI/BCU tool remotely to set the options below: **Dust Filter**

- - Disable* Enable

Dust Filter Reminder (Days)

15, 30, 60*, 90, 120, and 180

Technical Specifications - Other Hardware

Z2 G5 Dust Filter (Filter Only)

Part Number

3TQ24AA

This is intended to be a replacement filter for the HP Z2 Tower G5 Workstation in event that the original filter would need to be replaced.

HP Z2 Tower G5 Workstation Front Card Guide Kit **Part Number**

4KY82AA

Features

This front card guide kit is required to enable added mechanical stability when configuring select graphics cards on the HP Z2 Tower G5 Workstation.

The kit enables added mechanical stability when configuring:

- 2x AMD W2100 graphics cards
- AMD Radeon[™] Pro WX 3100 4GB Graphics
- AMD Radeon[™] Pro WX 3200 4GB Graphics
- AMD Radeon[™] Pro WX 4100 4GB Graphics
- AMD Radeon[™] Pro WX 7100 8GB Graphics
- 3x NVIDIA® NVS NVS 310 or NVS 315 graphics cards
- 2x NVIDIA® NVS 510 graphics cards
- 1x NVS 310 plus 1x NVS 510 graphics cards
- 1x NVIDIA® Quadro® M4000, M5000 graphics cards
- 1x AMD FirePro W7000 graphics card
- NVIDIA® Quadro® P1000 4GB Graphics
- NVIDIA® Quadro® P2000 5GB Graphics
- NVIDIA® Quadro® P2200 5GB Graphics
- NVIDIA® Quadro® P4000 8GB Graphics
- NVIDIA® Quadro® RTX 4000 8GB Graphics
- NVIDIA® Quadro® P5000 16GB Graphics
- NVIDIA® Quadro® RTX 5000 16GB Graphics
- NVIDIA® Quadro® RTX6000 24GB Graphics

NOTE: If one of the above graphics cards is configured with the Z2 G5 TWR at time of purchase, the Front Card Guide kit is automatically included.

 If one of the above graphics cards is added as an aftermarket option, the Front Card Guide Kit (4KY82AA) is required, as a separate purchase, for installation of the graphics card.

Technical Specifications – Miscellaneous Features

MISCELLANEOUS FEATURES

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls
 system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state with
 affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computer
 more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
 - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically)
 - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy
 - 2 red + 4 white BIOS recovery is in progress
 - 3 red + 2 white Memory could not be initialized
 - 3 red + 3 white Graphics adaptor could not be found
 - 3 red + 4 white Power supply failure / not connected
 - 3 red + 5 white Processor not installed
 - 3 red + 6 white Current processor does not support an enabled feature
 - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
 - 4 red + 3 white System internal temperature has exceeded its threshold
 - 5 red + 2 white System controller firmware is not valid
 - 5 red + 3 white System controller detected BIOS is not executing
 - 5 red + 4 white BIOS could not complete initialization / PCA failure
 - 5 red + 5 white System controller rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Blue Pull Tabs, and Quick Release Latches for easy Identification

Summary of Changes

Date of change:	Version History:	Description of change:
	From v1 to v2	

title

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